

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT																
NATURE OF CONVEYANCE:	ASSIGNMENT																
CONVEYING PARTY DATA																	
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CORRESPONDENCE DATA																	
<p>Fax Number: (312)876-7934 <i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i></p> <p>Phone: 3128768000 Email: bhannon@sonnenschein.com Correspondent Name: Sonnenschein Nath & Rosenthal LLP Address Line 1: Post Office Box 061080 Address Line 2: Wacker Drive Station, Sears Tower Address Line 4: Chicago, ILLINOIS 60606-1080</p>																	
ATTORNEY DOCKET NUMBER:	09792909-6648																

OP \$40.00 11419863

NAME OF SUBMITTER:

David R. Metzger

Total Attachments: 2

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ASSIGNMENT

FOR a valuable consideration, the sufficiency and receipt of which is hereby acknowledged, the undersigned whose mailing address(es) is/are:

c/o Sony Corporation
7-35 Kitashinagawa 6-chome
Shinagawa-ku, Tokyo 141-0001, Japan

hereby sell(s), assign(s) and transfer(s) unto Sony Corporation, a corporation of Japan, having its principal office at 7-35 Kitashinagawa 6-chome, Shinagawa-ku, Tokyo 141-0001, Japan, the whole right, title and interest in and to a certain invention or improvement in

CATHODE ACTIVE MATERIAL, METHOD OF MANUFACTURING IT, CATHODE, AND BATTERY

disclosed in an application for Letters Patent of the United States, prepared by the firm of Sonnenschein, Nath & Rosenthal of Chicago, Illinois, and executed of even date herewith, said application being identified in the office records of said firm as Case No. 09792909-6648, and in and to the United States Letters Patent therefor, when issued, together with all improvements thereon and betterments thereof, all divisions, continuations and reissues thereof and substitutions of or for said application, and all rights and privileges under the Letters Patent that may be granted therefor, including the right to claim the benefit of an earlier filing date for the same invention in a foreign country.

I/We hereby authorize and request the Commissioner of Patents to issue the Letters Patent that may be granted for said invention or improvements to said Sony Corporation.

For the same consideration, I/we hereby agree that I/we will promptly communicate to the aforesaid assignee or its assigns full and complete information concerning said improvements or betterments of the inventions disclosed in said application, and will cooperate at any time upon request of said assignee or its assigns, at its expense, in the procurement of patent protection to cover the inventions herein assigned and to be assigned, including the execution of new, divisional, continuing and reissue applications; will make all rightful oaths, will testify in any proceedings in the United States Patent Office or in the Courts, and generally will do everything lawfully possible to aid said assignee, its successors, assigns and nominees to obtain, enjoy and enforce proper patent protection for the inventions embraced within the terms of this document.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: Serial Number: 11/419,863, Filing Date: May 23, 2006.

DATE: July 10, 2006

HARUO WATANABE
HARUO WATANABE

DATE: August 2, 2006

KENJI OGISU
KENJI OGISU

DATE: July 10, 2006

KOJI MORITA
KOJI MORITA

DATE: July 11, 2006

MASANORI SOMA
MASANORI SOMA

DATE: July 11, 2006

Yosuke Hosoya
YOSUKE HOSOYA

DATE: July 11, 2006

Hideto Azuma
HIDETO AZUMA

DATE: July 24, 2006

Tomoyo Ooyama
TOMOYO OOYAMA